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IR-1839 (2-2797)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of:

Mark PAVIER et al.

Date: December 29, 2003

Serial No.: 10/045,809

Group Art Unit: 2814

Filed: January 11, 2002

Examiner: P. Cao

Notice of Allowance: November 12, 2003

Confirmation No.: 2069

For: CLIP-TYPE LEAD FRAME FOR SOURCE MOUNTED DIE

Mail Stop Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Attn: Official Draftsperson

**SUBMISSION OF FORMAL DRAWINGS**

Sir:

Responsive to the Notice of Allowance dated November 12, 2003, enclosed herewith please find three (3) sheets of formal drawings containing Figures 1 through 6 for the above-identified application.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, Washington, D.C. 20231, on December 29, 2003:

Respectfully submitted,

Samuel H. Weiner

Registration No.: 18,510

OSTROLENK, FABER, GERB & SOFFEN, LLP

1180 Avenue of the Americas

New York, NY 10036-8403

Telephone No.: (212) 382-0700

Samuel H. Weiner

Name of applicant, assignee or  
Registered Representative

Signature

December 29, 2003

Date of Signature

SHW:lac

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01-02-2004

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